

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
30V	7mΩ@10V	36A
	9.5mΩ@4.5V	
-30V	9.5mΩ@-10V	-34A
	11.5mΩ@-4.5V	



合肥矽普半导体

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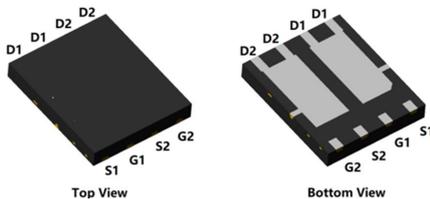
### Feature

- Fast switching speed
- Surface mount package
- ROHS Compliant & Halogen-Free
- 100% Single Pulse avalanche energy Test

### Applications

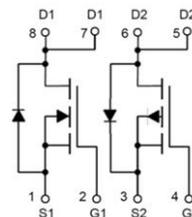
- DC-DC Converters.
- Motor Control.

### Package



PDFN5X6-8L

### Circuit diagram



### Marking



SP3011AACNK  
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:Device Code  
:Week Code

### Order Information

Device	Package	Unit/Tape
SP3011AACNK	PDFN5X6-8L	5000

**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Rating		Unit
		N-Channel	P-Channel	
Drain-Source Voltage	$V_{DS}$	30	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	$\pm 20$	V
Continuous Drain Current (Tc=25°C)	$I_D$	36	-34	A
Continuous Drain Current (Tc=100°C)	$I_D$	24	23	A
Pulse Drain Current Tested	$I_{DM}$	144	136	A
Single pulsed avalanche energy <sup>1</sup>	$E_{AS}$	210	130	mJ
Power Dissipation (Tc=25°C)	$P_D$	52		W
Power Dissipation (Tc=100°C)	$P_D$	21		W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	2.4		°C/W
Storage Temperature Range	$T_{STG}$	-55 to 150		°C
Operating Junction Temperature Range	$T_J$	-55 to 150		°C

**N-Electrical characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=24V, V_{GS}=0V, T_J=25^\circ C$	-	-	1	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.0	1.6	2.2	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$	-	7	11	m $\Omega$
		$V_{GS}=4.5V, I_D=10A$	-	9.5	15	
Gate Resistance	$R_G$	$V_{DS}=15V, V_{GS}=0V, f=1MHz$	-	2.2	-	$\Omega$
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=15V, V_{GS}=0V, f=1MHz$	-	1910	-	pF
Output Capacitance	$C_{oss}$		-	288	-	
Reverse Transfer Capacitance	$C_{rss}$		-	262	-	
Total Gate Charge	$Q_g$	$V_{DS}=15V, V_{GS}=10V, I_D=20A$	-	45	-	nC
Gate-Source Charge	$Q_{gs}$		-	6	-	
Gate-Drain Charge	$Q_{gd}$		-	12	-	
Gate Plateau Voltage	$V_{plateau}$		-	3.5	-	
<b>Switching Characteristics</b>						
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=15V, V_{GS}=10V, R_G=3\Omega, I_D=20A$	-	9.6	-	nS
Rise Time	$T_r$		-	10.2	-	
Turn-Off Delay Time	$T_{d(off)}$		-	116	-	
Fall Time	$T_f$		-	24	-	
<b>Diode Characteristics</b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=1A, T_J=25^\circ C$	-	-	1.2	V
Diode Continuous Current	$I_S$		-	-	36	A
Reverse recover time	$T_{rr}$	$I_S=20A, di/dt=100A/\mu s, T_J=25^\circ C$	-	16	-	nS
Reverse recovery charge	$Q_{rr}$		-	38	-	nC

**Note:**

- The EAS test condition is  $V_{DD}=15V, V_{GS}=10V, L=0.5mH, R_g=25\Omega$

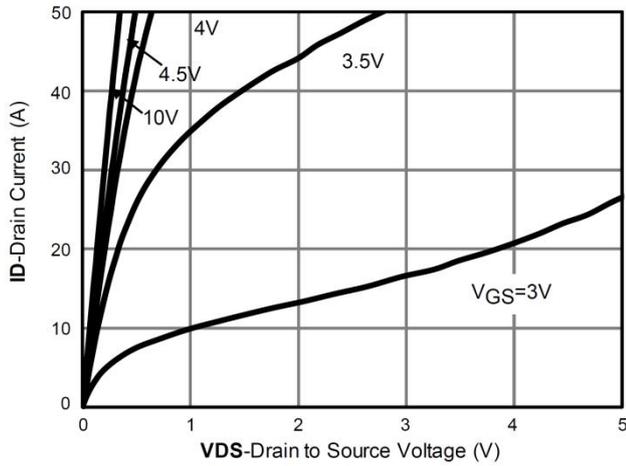
**P-Electrical characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	VGS=0V , ID=-250uA	-30	-	-	V
Drain-Source Leakage Current	IDSS	VDS=-24V , VGS=0V , TJ=25°C	-	-	-1	uA
Gate-Source Leakage Current	IGSS	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	VGS(th)	VGS=VDS , ID=-250uA	-1.0	-1.6	-2.2	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	VGS=-10V , ID=-20A	-	9.5	13	mΩ
		VGS=-4.5V , ID=-10A	-	11.5	18	
Gate Resistance	R <sub>G</sub>	VDS=-15V , VGS=0V , f=1MHz	-	5.5	-	Ω
<b>Dynamic characteristics</b>						
Input Capacitance	C <sub>iss</sub>	VDS=-15V , VGS=0V , f=1MHz	-	1800	-	pF
Output Capacitance	C <sub>oss</sub>		-	238	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	212	-	
Total Gate Charge	Q <sub>g</sub>	VDS=-15V , VGS=-10V , ID=-20A	-	38	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	6	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	8	-	
Gate Plateau Voltage	V <sub>plateau</sub>		-	3.5	-	
<b>Switching Characteristics</b>						
Turn-On Delay Time	T <sub>d(on)</sub>	VDD=-15V , VGS=-10V , RG=3Ω , ID=-20A	-	38	-	nS
Rise Time	T <sub>r</sub>		-	42	-	
Turn-Off Delay Time	T <sub>d(off)</sub>		-	28	-	
Fall Time	T <sub>f</sub>		-	12	-	
<b>Diode Characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	VGS=0V , IS=-1A , TJ=25°C	-	-	-1.2	V
Diode Continuous Current	I <sub>S</sub>		-	-	-34	A
Reverse recover time	T <sub>rr</sub>	IS=-20A , di/dt=-100A/us , TJ=25°C	-	16	-	nS
Reverse recovery charge	Q <sub>rr</sub>		-	6.8	-	nC

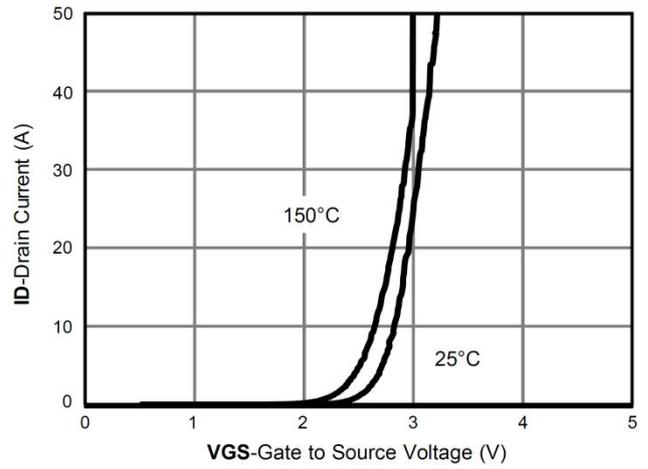
**Note:**

- The EAS test condition is VDD=-15V, VGS=-10V, L=0.5mH, Rg=25Ω

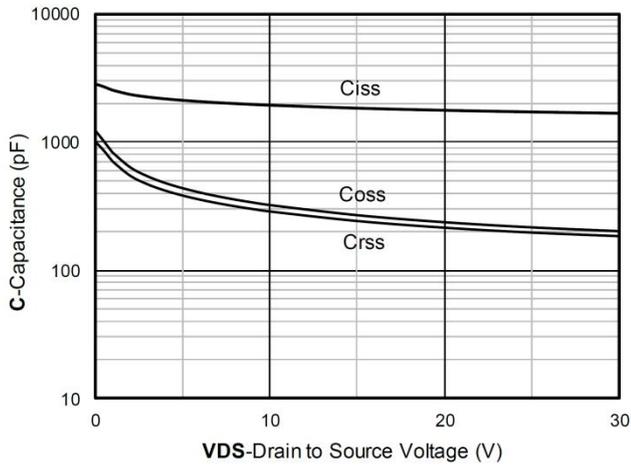
**N-Channel Typical Characteristics**



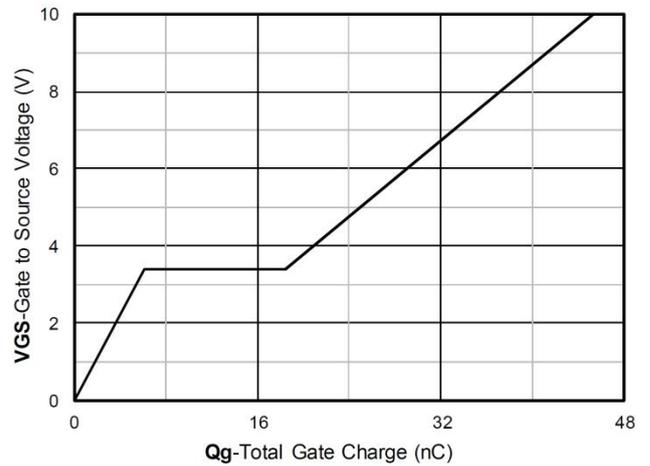
Output Characteristics



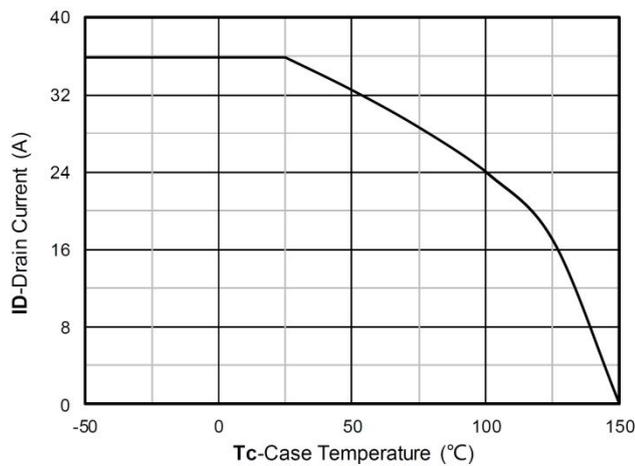
Transfer Characteristics



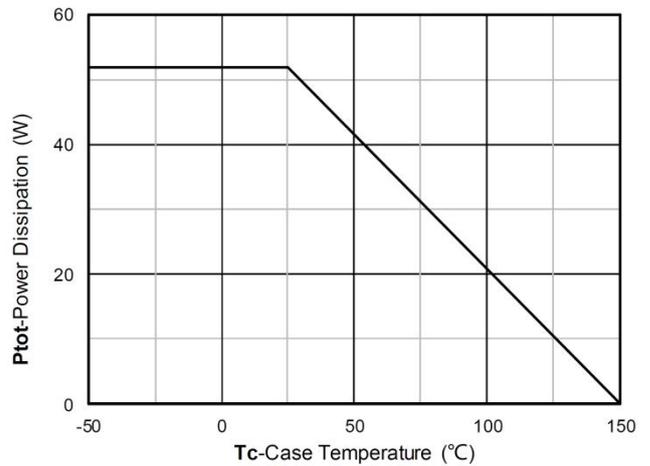
Capacitance Characteristics



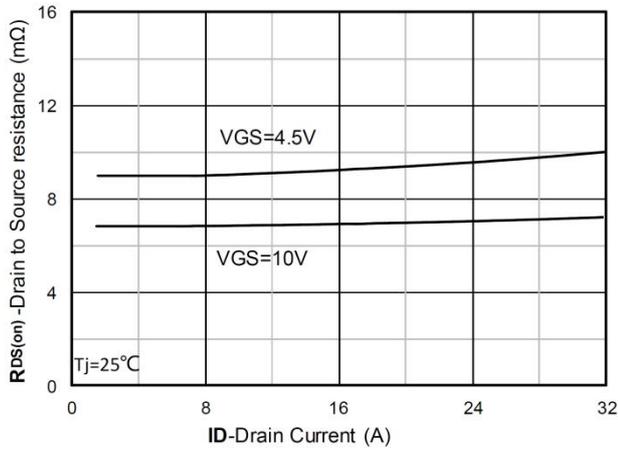
Gate Charge



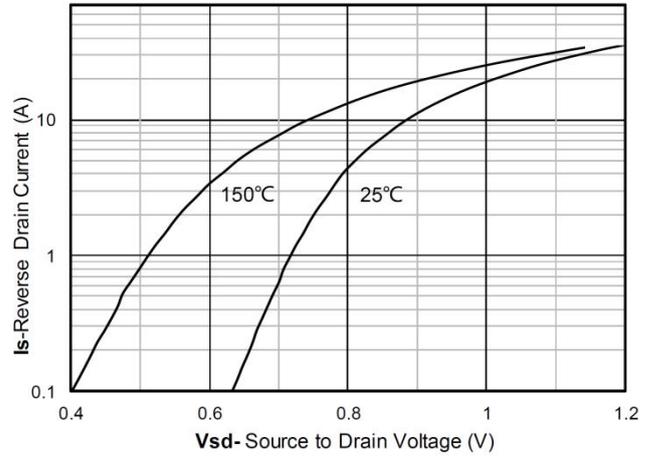
Current dissipation



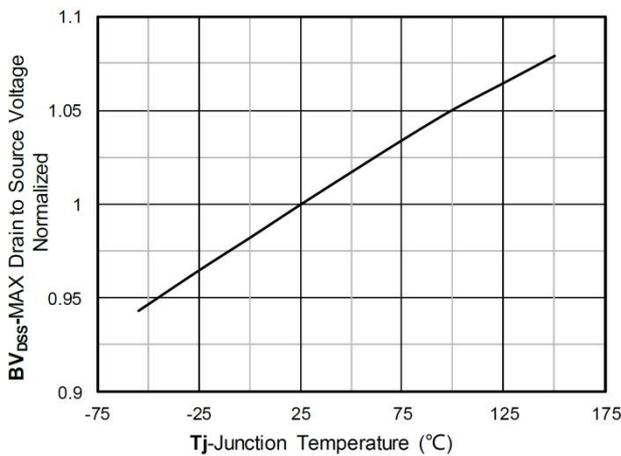
Power dissipation



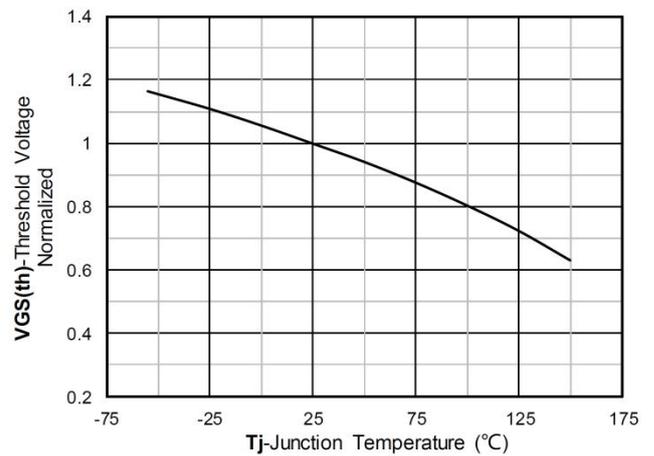
RDS(on) VS Drain Current



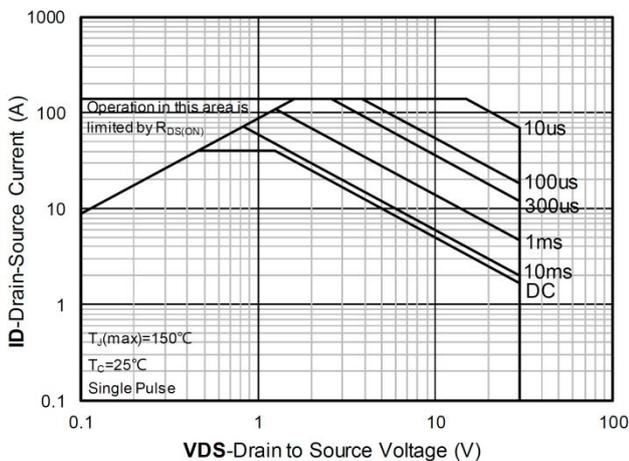
Forward characteristics of reverse diode



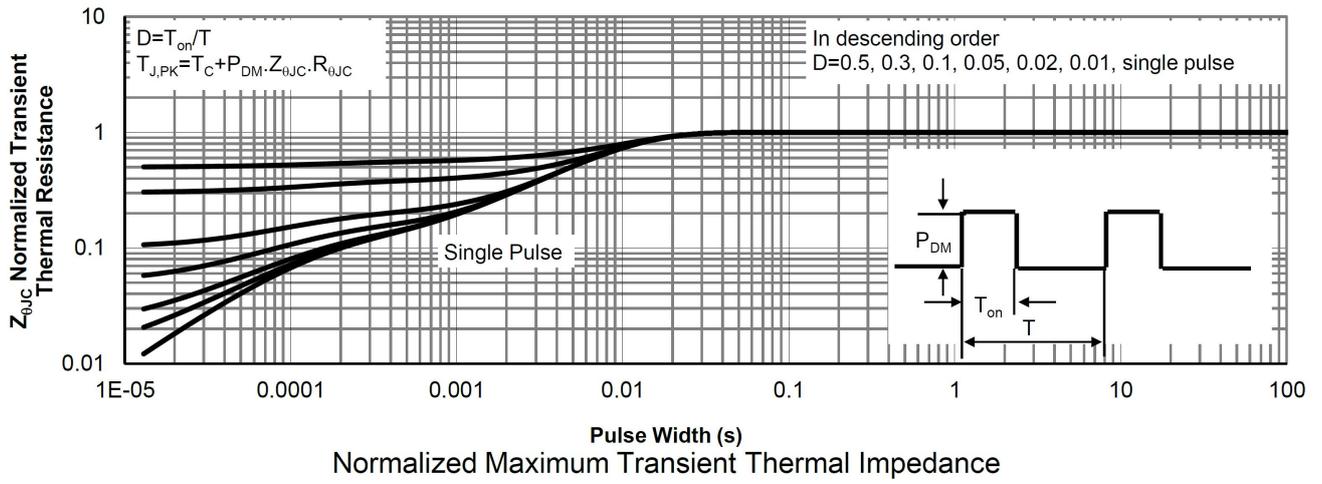
Normalized breakdown voltage



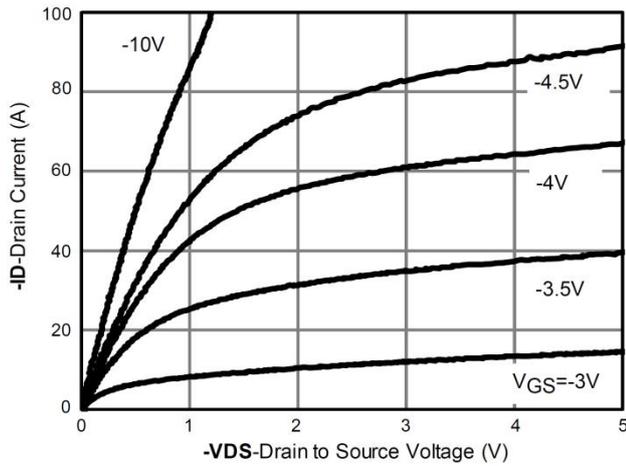
Normalized Threshold voltage



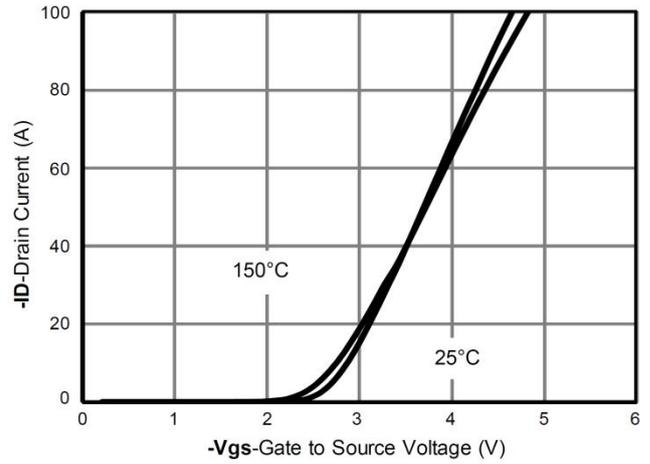
Safe Operation Area



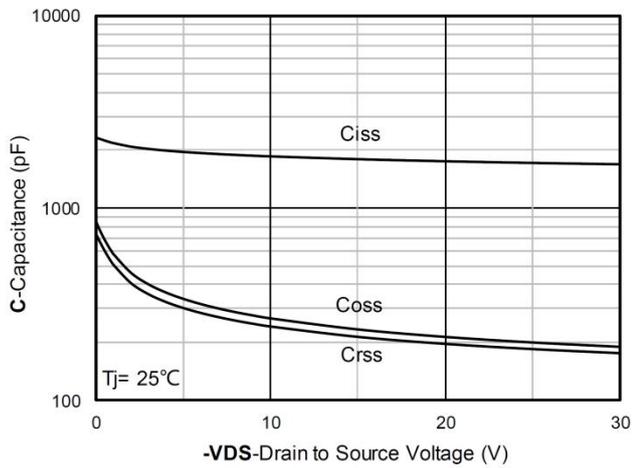
**P-Channel Typical Characteristics**



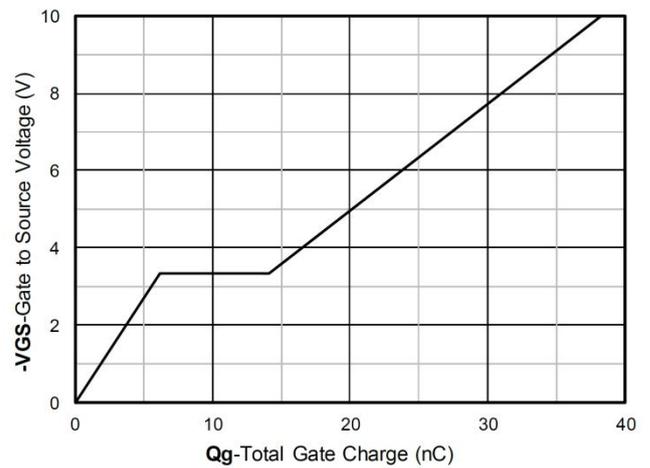
Output Characteristics



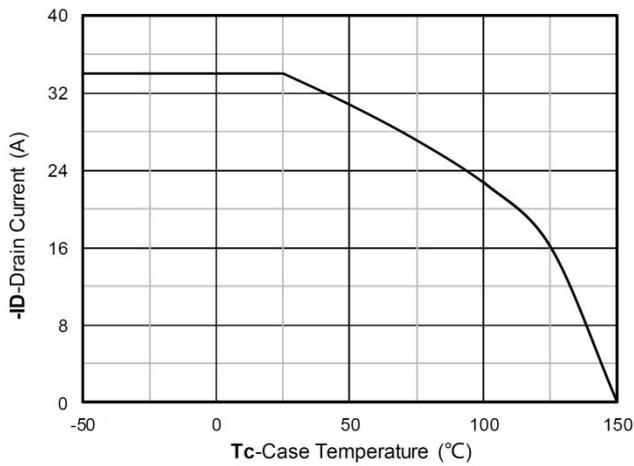
Transfer Characteristics



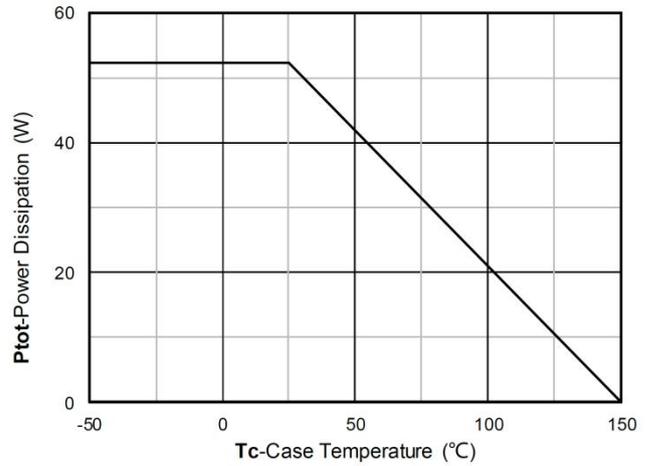
Capacitance Characteristics



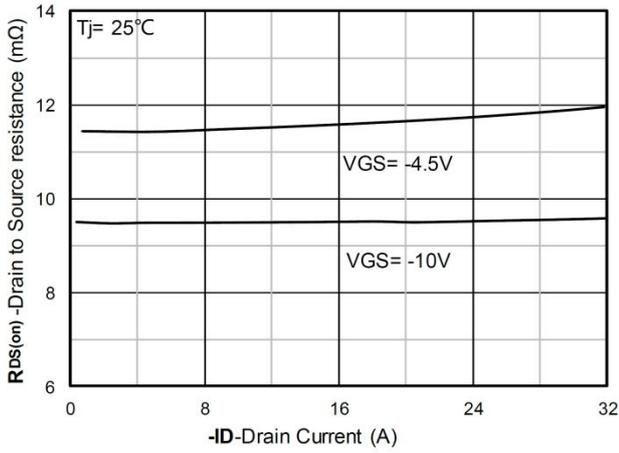
Gate Charge



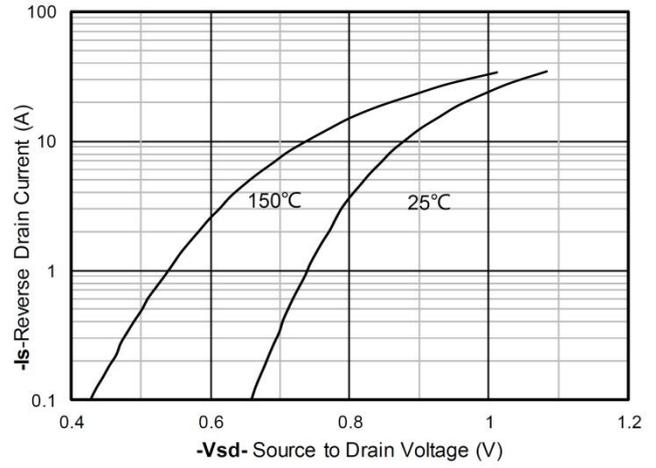
Current dissipation



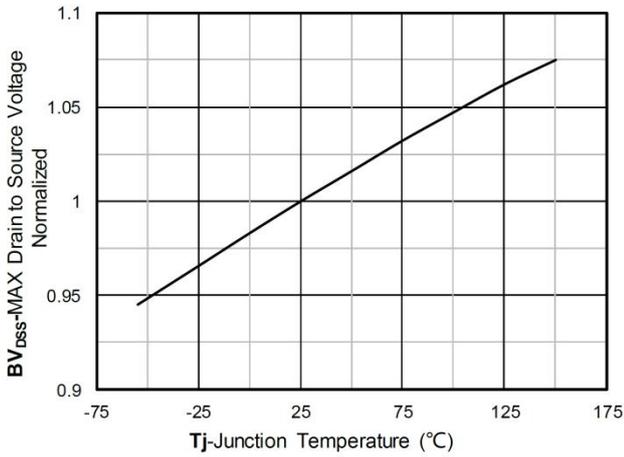
Power dissipation



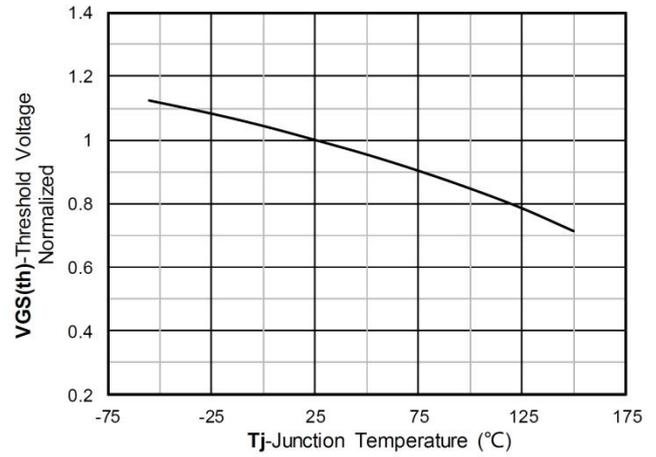
RDS(on) VS Drain Current



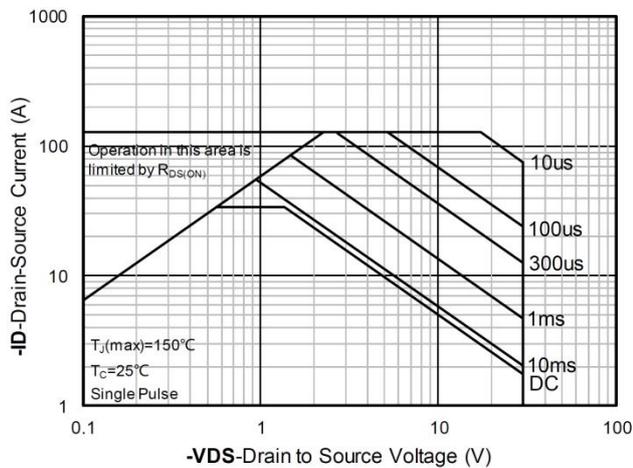
Forward characteristics of reverse diode



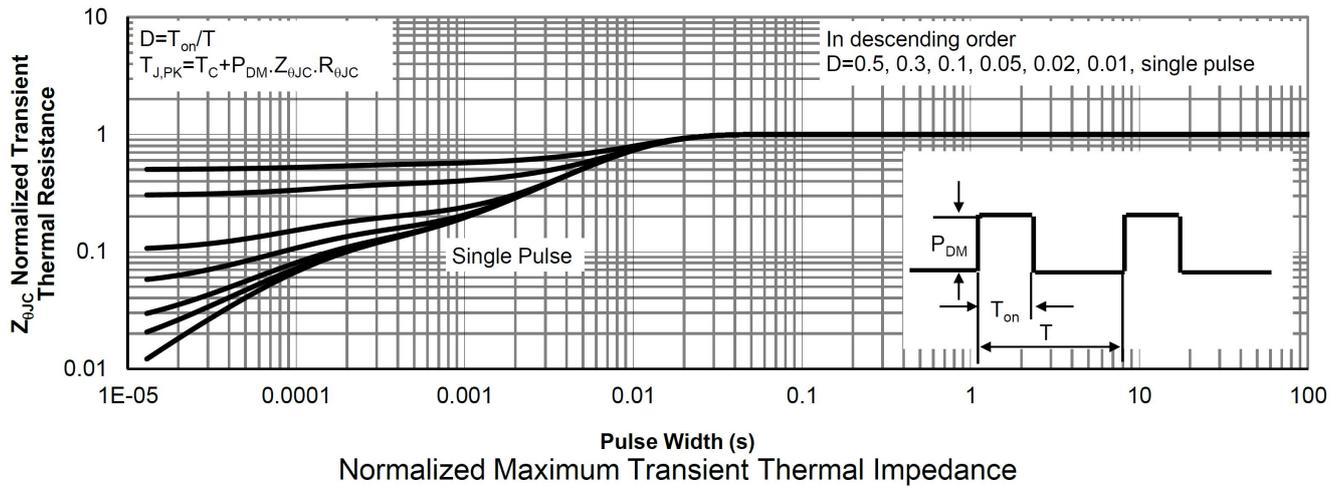
Normalized breakdown voltage



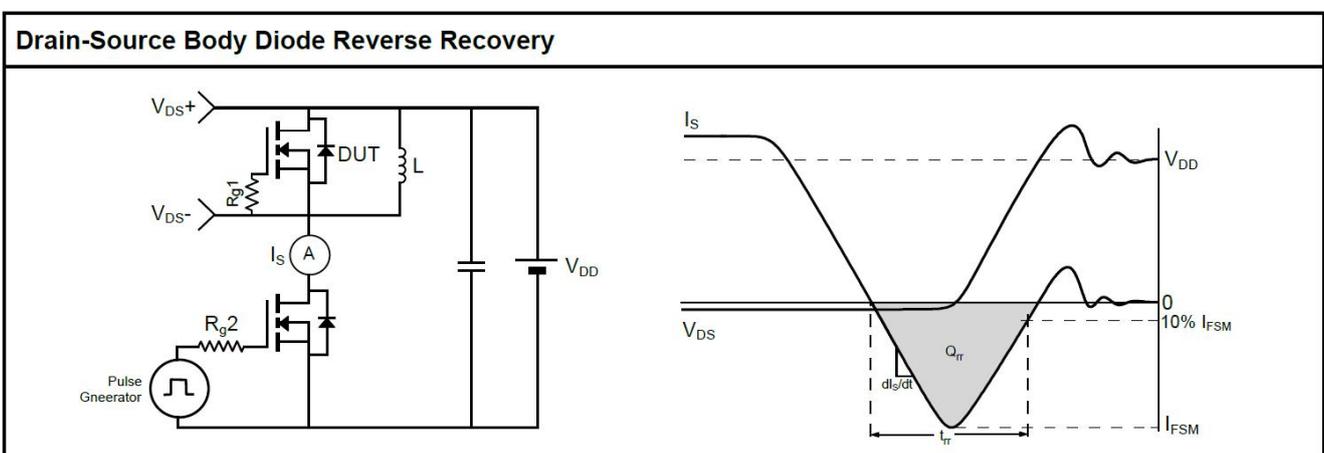
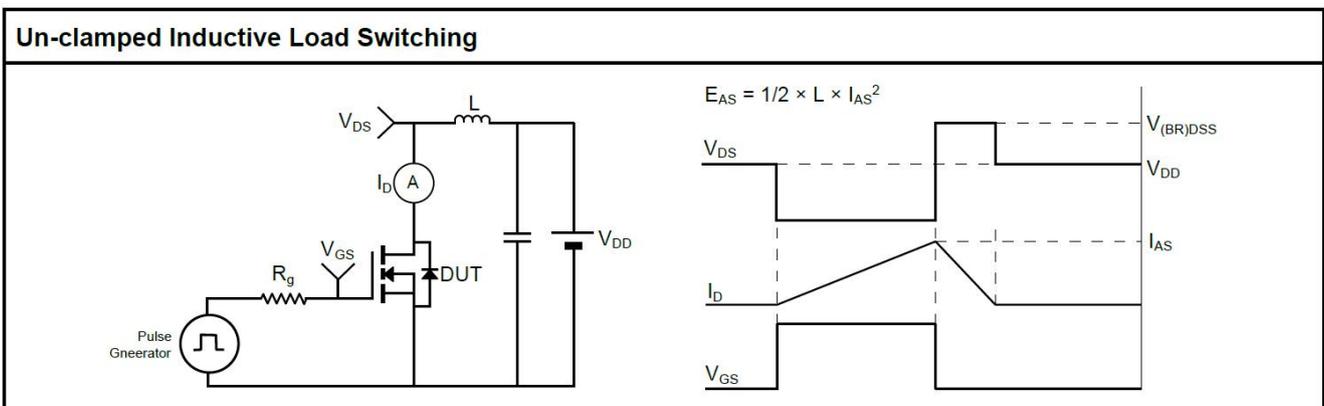
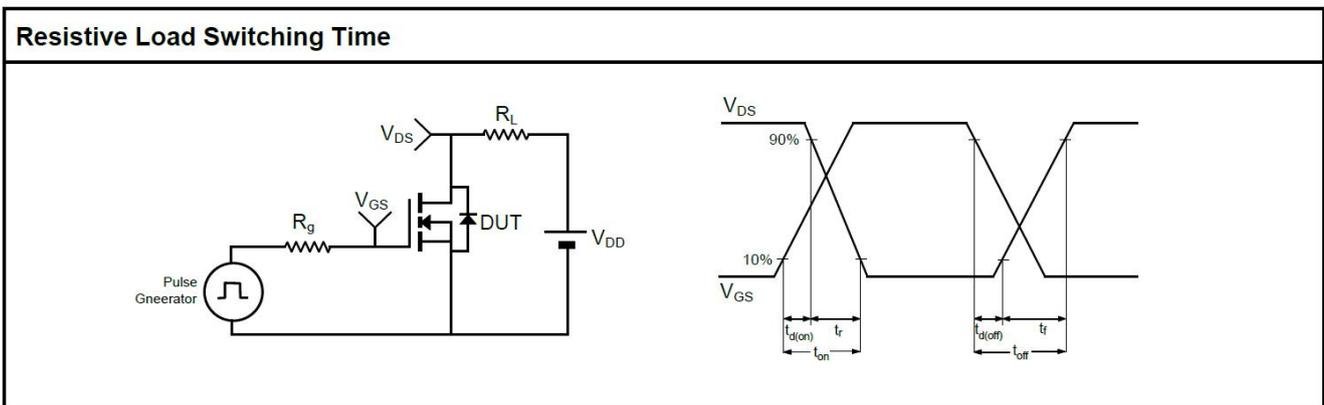
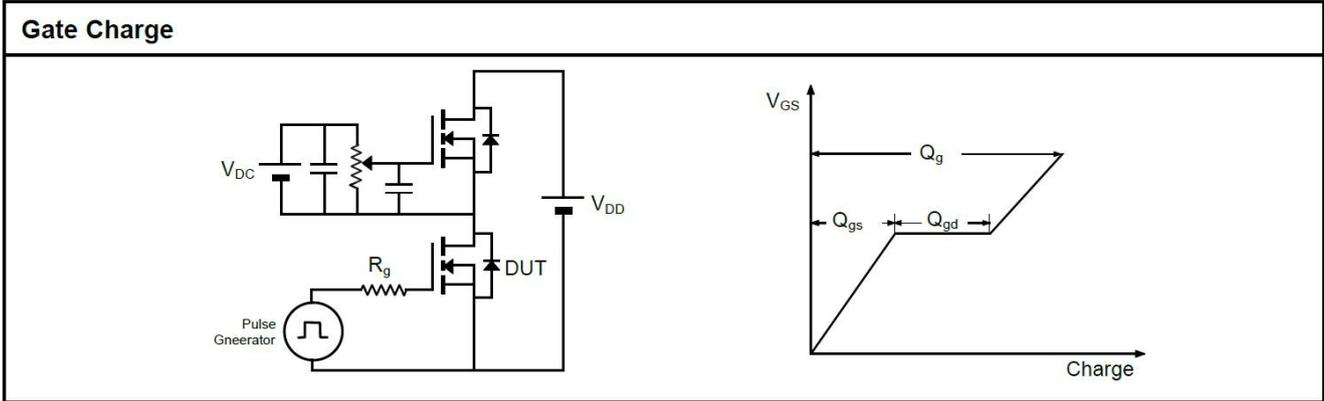
Normalized Threshold voltage



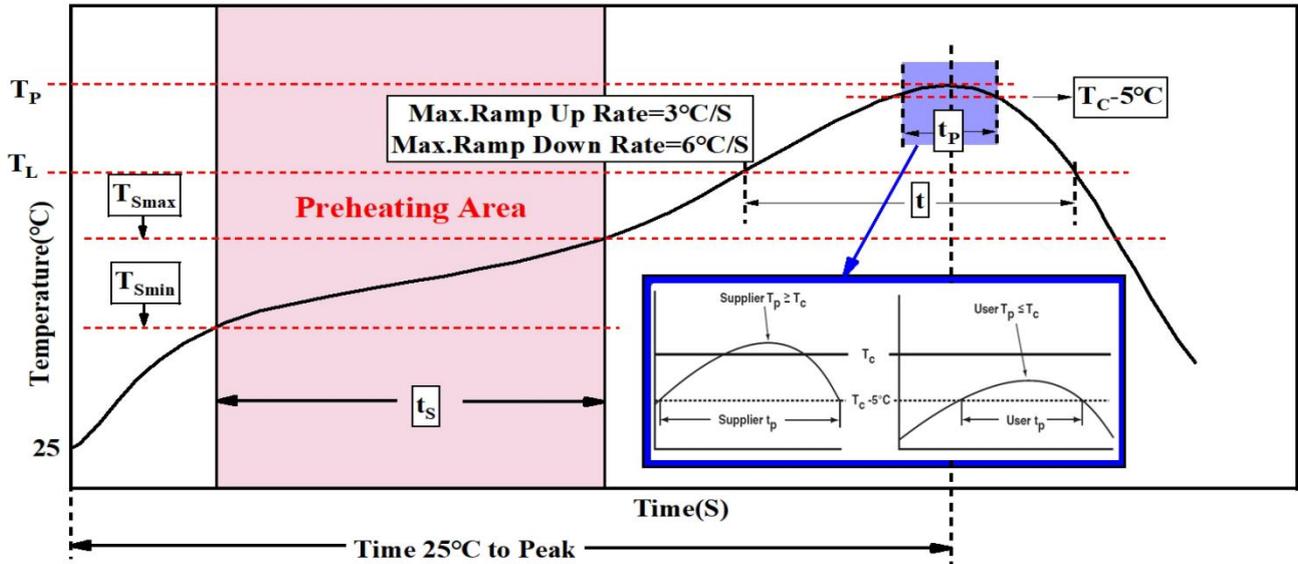
Safe Operation Area



Test Circuit



**Temperature Profile for IR Reflow Soldering**



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b>		
Temperature min (T <sub>smin</sub> )	100°C	150°C
Temperature max (T <sub>smax</sub> )	150°C	200°C
Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds
Average ramp-up rate (T <sub>smax</sub> to T <sub>p</sub> )	3 °C/second max.	3°C/second max.
Liquidous temperature (T <sub>L</sub> )	183 °C	217°C
Time at liquidous (t <sub>L</sub> )	60-150 seconds	60-150 seconds
Peak package body Temperature e (T <sub>p</sub> )*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t <sub>p</sub> )** within 5°C of the specified classification temperature (T <sub>c</sub> )	20** seconds	30** seconds
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T <sub>p</sub> ) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t <sub>p</sub> ) is defined as a supplier minimum and a user maximum		

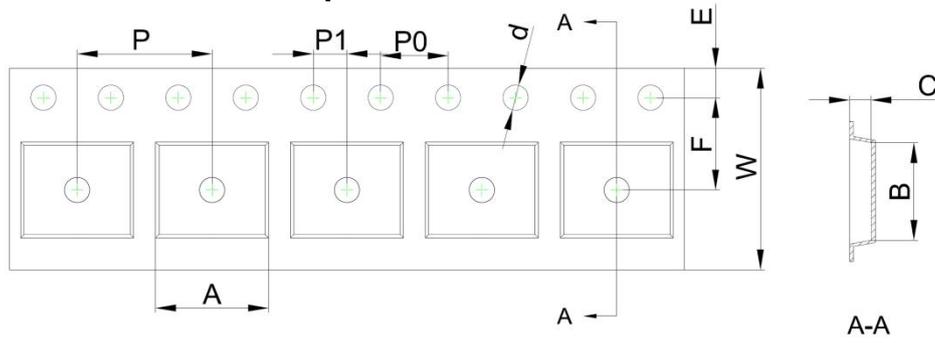
Table 1. SnPb Eutectic Process – Classification Temperatures (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (T<sub>c</sub>)

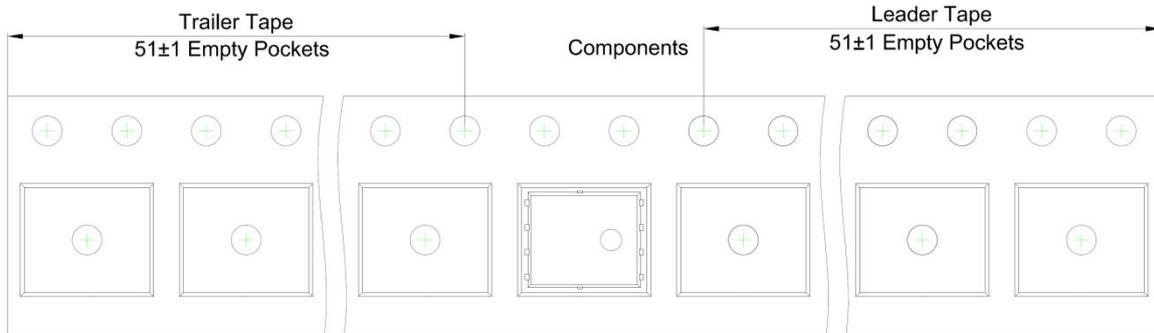
Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

**PDFN5X6-8L Embossed Carrier Tape**

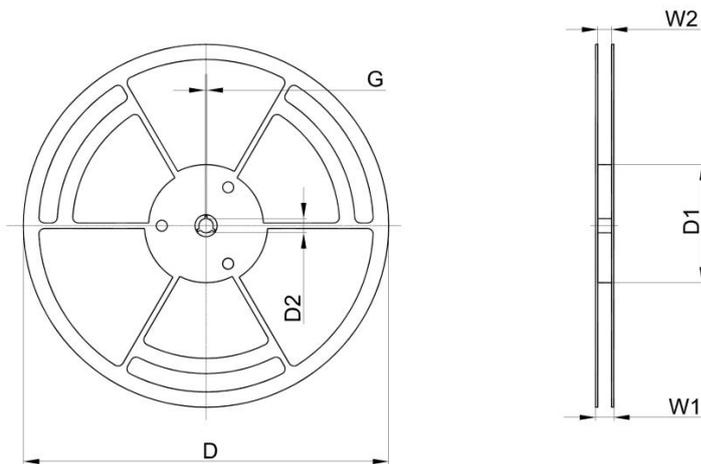


Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFN5X6-8L	6.30	5.30	1.10	Φ1.50	1.75	5.50	4.00	8.00	2.00	12.00

**PDFN5X6-8L Tape Leader and Trailer**



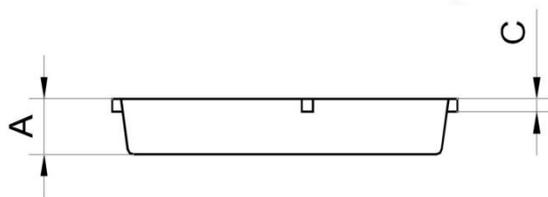
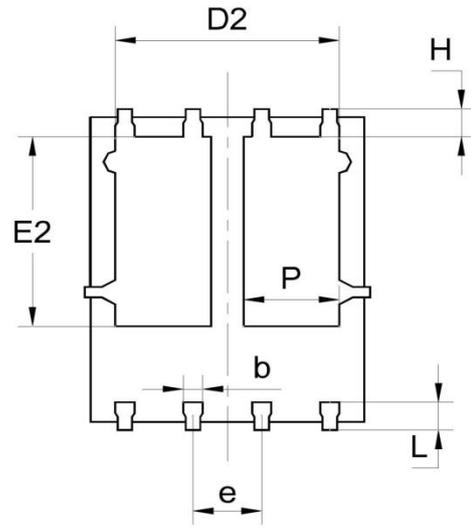
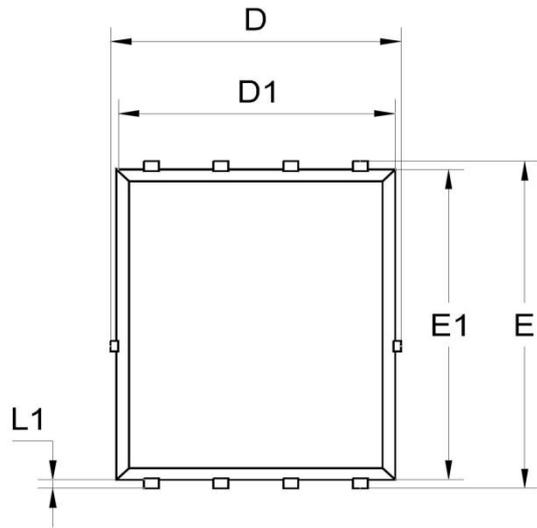
**PDFN5X6-8L Reel**



Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13" Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365

**PDFN5X6-8L Package Information**



Side View [侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.120	0.035	0.044
b	0.330	0.510	0.013	0.020
C	0.110	0.340	0.004	0.013
D	4.700	5.260	0.185	0.207
D1	4.700	5.100	0.185	0.201
D2	3.560	4.500	0.140	0.177
E	5.750	6.250	0.226	0.246
E1	5.600	6.000	0.220	0.236
E2	3.180	3.660	0.125	0.144
e	1.170	1.370	0.046	0.054
L	0.350	0.710	0.014	0.028
L1	0.060	0.200	0.002	0.008
H	0.350	0.710	0.014	0.028
P	1.700	2.300	0.067	0.091